

Business Opportunities for Japanese Firms in India's Logistics & Material Handling

■ Date	August 24, 2018 (FRI) 13:30 - 16:30 (Reception open from 13:00)
■ Program	<p>13 : 30 – 13:40 Welcome Address Embassy of India, Tokyo (TBC)</p> <p>13 : 40 – 13:50 Greetings by Mr. Yasuo Ohba, Chairman, Japan Material Flow Institute</p> <p>13 : 50 – 14:40 <u>Session 1: Mr. R. Dinesh, Chairman, CII Southern Region)</u> ◆ Industry Perspective on India's Logistics, Material Flow, Supply Chain</p> <p>14 : 40 – 15:00 <u>Session 2: Mr. Gaurav Malhotra, India Desk, Grant Thornton Japan</u> ◆ India's Logistics Network, Projects, GST</p> <p>15 : 00 – 15:15 <u>Session 3: Mr. Prashant Godghate, Secretary General, JIIPA</u> ◆ About Asia Seamless Forum to be held in India during IETF</p> <p>15 : 15 - 15 : 30 Q & A</p> <p>15 : 30 - 16 : 30 Networking</p>
■ Location	Indian Embassy in Japan, Auditorium, 2-2-11 Kudan-minami, Chiyoda-ku, Tokyo TEL: 03-3262-2391 (3 minute-walk from Exit 2 of Tokyo Metro 'Kudanshita Station') Map: http://www.embassyofindiajapan.org/new/src_JP/contactus/contactus.htm
■ Organizer	Confederation of Indian Industry (CII), Japan India Industry Promotion Association (JIIPA)
■ Supporter (TBC)	Embassy of India, Tokyo, Japan Material Flow Institute, The Japan External Trade Organization (Jetro), Japan India Business Cooperation Committee (JIBCC), Japan India Association, Yokohama India Center, Japan
■ Entrance Fee	Free of charge
■ Language	Consecutive Japanese-English interpreting provided.
■ Attendees	150 persons (On a first come, first served basis; no entry will be permitted once the pre-determined number of attendees is reached).
■ Application	Deadline for Applications: Aug 22, 2018 FAX TO: 03-5733-5047 Japan India Industry Promotion Association (JIIPA)
■ Enquiries	Japan India Industry Promotion Association (JIIPA) TEL: 03-5733-5068

Company Name		Industry / Business Area	
Department and Title		Name (Japanese)	
Address	(〒)		
Contact Details	(TEL)	(FAX)	
	(E-mail)		

FAX : 03-5733-5047

Application Deadline : 22/08/ 2018